



Main Features

- Low Power COM Express CPU Module
- Onboard Intel® Atom™ Dual Core D525 1.8GHz Processor
- Intel® ICH8M Chipset
- Support DDR2 667 and 800 SO-DIMM up to 2GB
- Intel® PCI Express GbE 82574L
- Support 3 x SATA, 1 x IDE, 8 x USB2.0 for fast peripherals
- Micro COM Express Type II supports up to 5 Express lanes, 32 bit PCI interface and one IDE and Gigabit LAN

Product Overview

The ICES 253 is a COM Express Type 2 compact module that features Intel® Atom™ D525 1.8GHz and ICH8M in small foot print. ICES 253 provides outstanding performance in the combination of high computing power and low thermal dissipation.

ICES 253 supports DDR2 667 SO-DIMM memory up to 2GB, and supports 3 x SATA, 1 x IDE, 8 x USB2.0 for fast peripherals.

ICES 253 is type 2 COM Express Module support up to 5 Express lanes, 32 bit PCI interface and one IDE and Gigabit LAN.

Specifications

CPU Support

- Onboard Intel® Atom™ Dual Core D525 1.8GHz Processor

Chipset

- Intel® ICH8M chipsets

Main Memory

- Support one un-buffered non-ECC DDR2 SO-DIMM 667 and 800 up to 2GB

BIOS

- AMI System BIOS
- SPI ROM
- Plug & Play support
- Advanced Power Management and Advanced Configuration & Power Interface support

Display

- Intel® Atom™ D525 integrated graphics solution with dynamic video memory allocation
- Analog monitor with pixel resolution up to 2048 x 1536 @60Hz
- Support Single channel for 18 bit
- LFP (local flat panel) LVDS interface

On-board LAN

- Intel® PCI Express GbE 82574L x 1
- Support PXE LAN boot function
- Support Wake on LAN function

Other Interfaces

- One 3pin fan connector (90 degree, 12V)

Storage

- 3 x SATA
- 1 x IDE

Interface

- Reset signal
- 8 GPIO lines (GPI 0~3 and GPO0~3), CMOS Level (0/3.3V)
- I2C Interface/SMbus Interface
- USB 2.0 x 8
- PATA

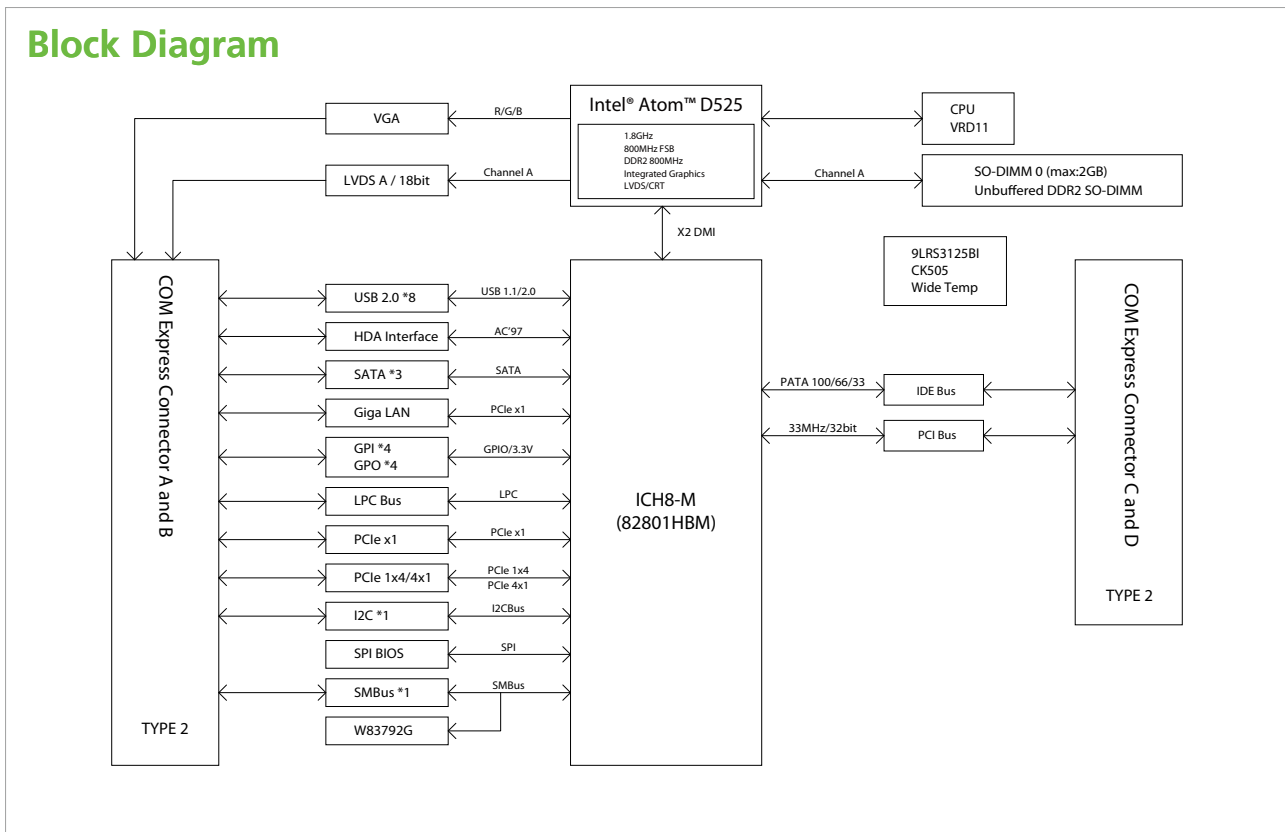
Extension

- One 32-bit PCI V2.3 interface
- One PCI express: 5 Lanes (via dip switch for 5 x 1 or 1 x 1+ 1 x 4)

Other Interfaces

- One 3pin fan connector (Reserved, 90 degree, 12V)

Block Diagram



COM Express Connector

- AB connector
VGA/LVDS/8 x USB/HD Audio interface/3 x SATA/LAN/GPIO(3.3V)/LPC bus/ 1 x PCIe x4/1 x PCIe x1/SMBus/I2C/SPI BIOS
- CD connector, IDE, PCI

Power Requirements

- +12Vdc, 3.3V battery, +5Vsb power input
- Support both AT and ATX power supply mode

Power Management

- ACPI 2.0 compliant with battery support. Also supports Suspend to RAM (S3)

System Monitor

- Monitoring of 4 voltages, 2 temperatures and 1 fan Speed
- 4 voltage (For +5V, +12V, Vcore, +3.3V)
- 2 Temperatures (CPU and one external Temperature Sensor)

Carrier Board

- ICEB 8050

Dimensions

- 95mm (W) x 95mm (L)

Environment

- Operating temperature: -20°C to 60°C
- Storage temperature: -20°C to 85°C
- Relative humidity:
10% to 97% (operating, non-condensing)
5% to 97% (non-operating, non-condensing)

Certifications

- CE approval
- FCC Class A

Ordering Information

◆ ICES 253 (P/N: 10K00025300X00)

COM Express Type 2 basic module with Intel® Atom™ D525 1.8GHz DDR2/ PCIe/ PCI/ IDE/ GbE/ LVDS/ audio interface

◆ ICEB 8050 (P/N: 10KB0805000X0)

COM Express Type 2 evaluation board with PCIe/ PCI/ SATA/ CF/ IDE/ COM/ USB/ LVDS/ VGA/ LAN